

# DF6A6.8FUT1

勝特力材料 886-3-5753170  
勝特力电子(上海) 86-21-54151736  
勝特力电子(深圳) 86-755-83298787  
[Http://www.100y.com.tw](http://www.100y.com.tw)

## Quad Array for ESD Protection

This quad voltage suppressor is designed for applications requiring transient overvoltage protection capability. It is intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment, and other applications. Its quad junction common anode design protects four separate lines using only one package. These devices are ideal for situations where board space is at a premium.

### Specification Features

- SC-88 Package Allows Four Separate Unidirectional Configurations
- Low Leakage < 1  $\mu$ A @ 5 Volt
- Breakdown Voltage: 6.4 – 7.2 Volt @ 5 mA
- Low Capacitance (40 pF typical)
- ESD Protection Meeting 61000-4-2 Level 4 and 16 kV Human Body Model
- Pb-Free Package is Available

### Mechanical Characteristics

- Void Free, Transfer-Molded, Thermosetting Plastic Case
- Corrosion Resistant Finish, Easily Solderable
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications

### MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Power Dissipation @ 8 x 20 $\mu$ s (Note 1)	$P_{pk}$	75	Watts
Steady State Power Dissipation (Note 2)	$P_D$	385	mW
Thermal Resistance – Junction-to-Ambient Derate Above 25°C	$R_{\theta JA}$	328 3.0	°C/W mW/°C
Maximum Junction Temperature	$T_{Jmax}$	150	°C
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150	°C
ESD Discharge MIL STD 883C – Method 3015-6 IEC61000-4-2, Air Discharge IEC61000-4-2, Contact Discharge	$V_{PP}$	16 16 8	kV
Lead Solder Temperature (10 seconds duration)	$T_L$	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

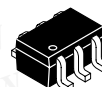
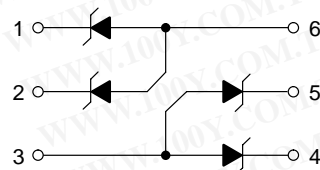
1. Per Waveform Figure 1

2. Mounted on FR-5 Board = 1.0 X 0.75 X 0.062 in.



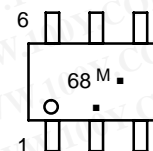
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SC-88  
CASE 419B-02

### MARKING DIAGRAM



68 = Specific Device Code

M = Date Code

■ = Pb-Free Package

(Note: Microdot may be in either location.)

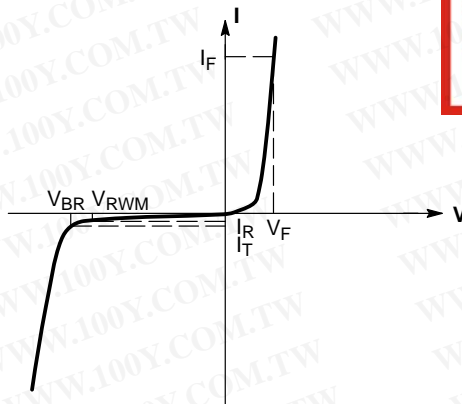
### ORDERING INFORMATION

Device	Package	Shipping†
DF6A6.8FUT1	SC-88	3000/Tape & Reel
DF6A6.8FUT1G	SC-88 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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V-I Curve

## ELECTRICAL CHARACTERISTICS

Device	Device Marking	Breakdown Voltage $V_{BR}$ @ 5 mA (Volts)			Leakage Current $I_{RM}$ @ $V_{RWM} = 5$ V ( $\mu$ A)	Typical Capacitance @ 0 V Bias (pF)	Max $V_F$ @ $I_F = 10$ mA (V)	Max $Z_Z$ @ 5 mA ( $\Omega$ )	Max $Z_{ZK}$ @ 0.5 mA ( $\Omega$ )
		Min	Nom	Max					
DF6A6.8FUT1	68	6.4	6.8	7.2	1.0	40	1.25	30	300

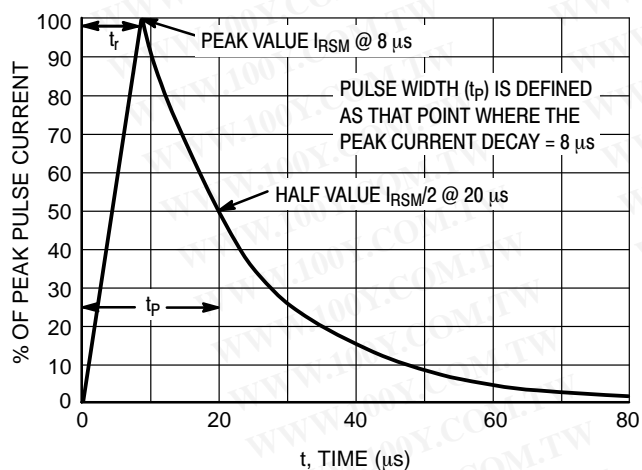


Figure 1.  $8 \times 20 \mu s$  Pulse Waveform

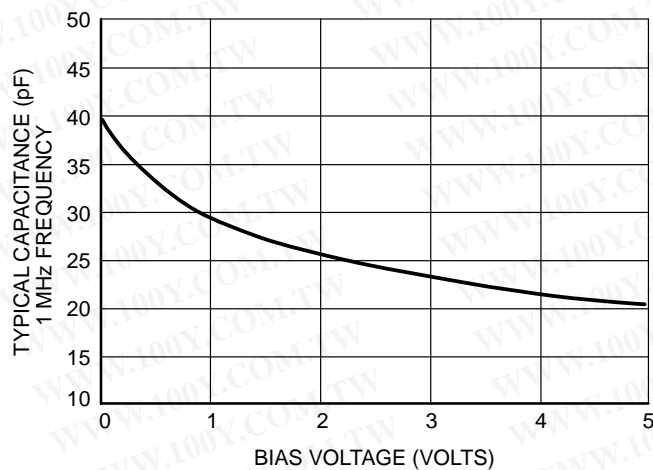


Figure 2. Capacitance

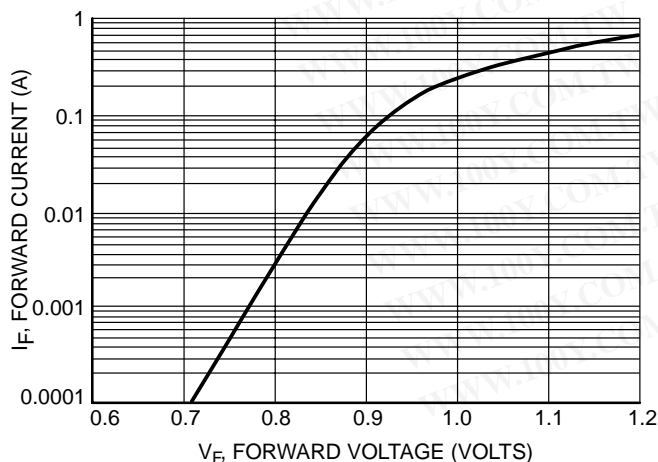


Figure 3. Forward Voltage

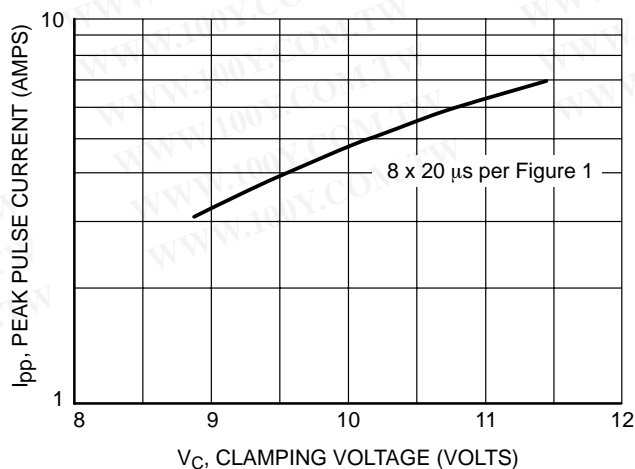


Figure 4. Clamping Voltage versus Peak Pulse Current

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## PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363

CASE 419B-02

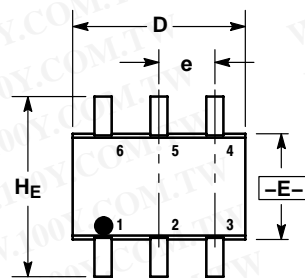
ISSUE V

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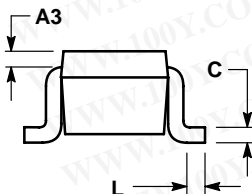
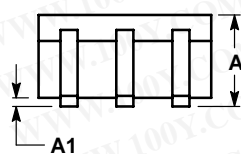
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⊕	0.2 (0.008)	(M)	E (M)
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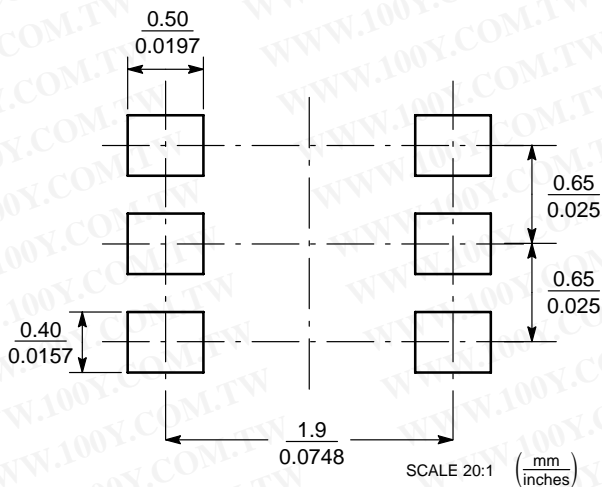


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
C	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e	0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
H_E	2.00	2.10	2.20	0.078	0.082	0.086

## SOLDERING FOOTPRINT\*




SC-88/SC70-6/SOT-363

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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